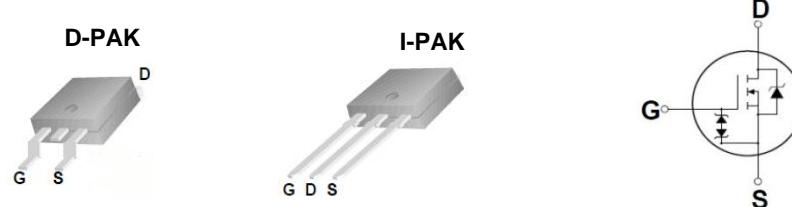


Features

- Low gate charge
- 100% avalanche tested
- Improved dv/dt capability
- RoHS compliant
- Halogen free package
- JEDEC Qualification

N-channel MOSFET		
BV_{DSS}	I_D	$R_{DS(on)MAX}$
600V	7A	<1.2Ω



Device	Package	Marking	Remark
TMD7N60Z / TMU7N60Z	D-PAK/I-PAK	TMD7N60Z / TMU7N60Z	RoHS
TMD7N60ZG / TMU7N60ZG	D-PAK/I-PAK	TMD7N60ZG / TMU7N60ZG	Halogen Free

Absolute Maximum Ratings

Parameter	Symbol	TMD7N60Z(G)/TMU7N60Z(G)	Unit
Drain-Source Voltage	V_{DSS}	600	V
Gate-Source Voltage	V_{GS}	±30	V
Continuous Drain Current $T_C = 25\text{ °C}$	I_D	7	A
		3.9	A
Pulsed Drain Current (Note 1)	I_{DM}	28	A
Single Pulse Avalanche Energy (Note 2)	E_{AS}	462	mJ
Repetitive Avalanche Current (Note 1)	I_{AR}	7	A
Repetitive Avalanche Energy (Note 1)	E_{AR}	12	mJ
Power Dissipation $T_C = 25\text{ °C}$	P_D	120	W
		0.96	W/°C
Peak Diode Recovery dv/dt (Note 3)	dv/dt	4.5	V/ns
Operating Junction and Storage Temperature Range	T_J, T_{STG}	-55~150	°C
Maximum lead temperature for soldering purposes, 1/8" from case for 5 seconds	T_L	300	°C

* Limited only by maximum junction temperature

Thermal Characteristics

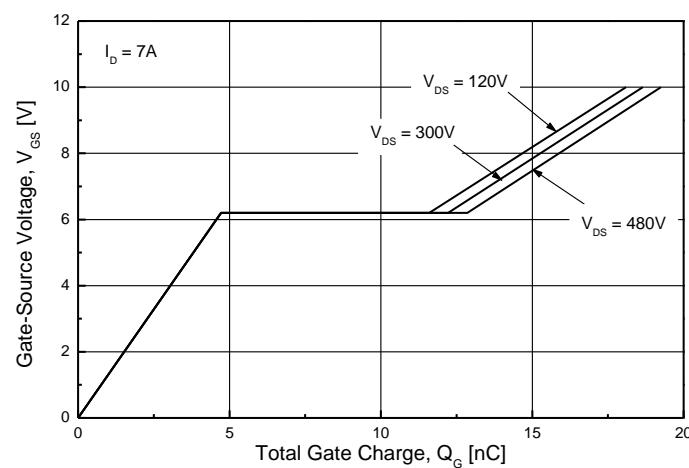
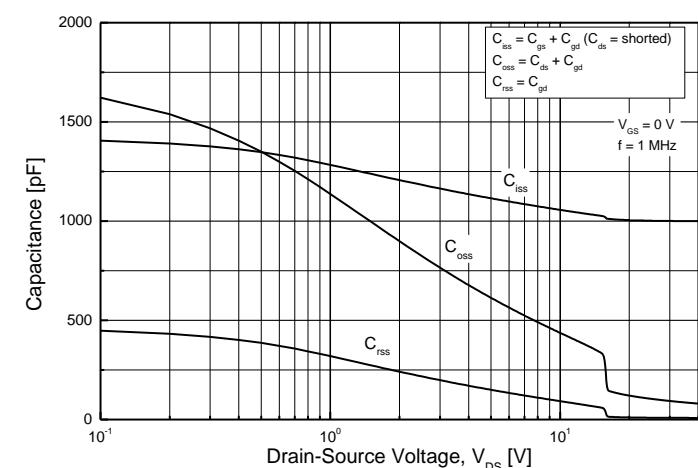
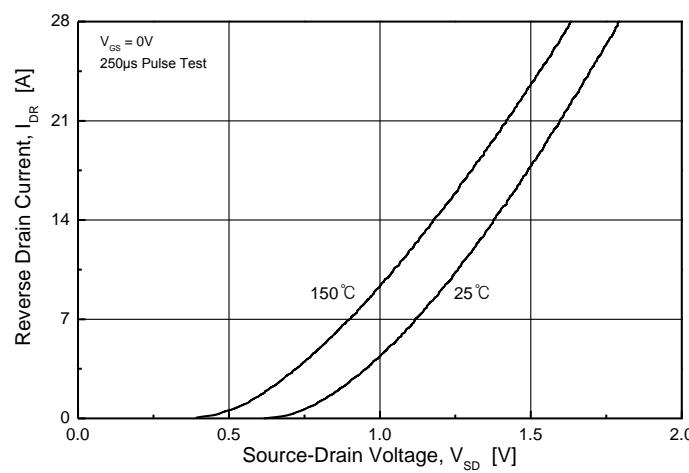
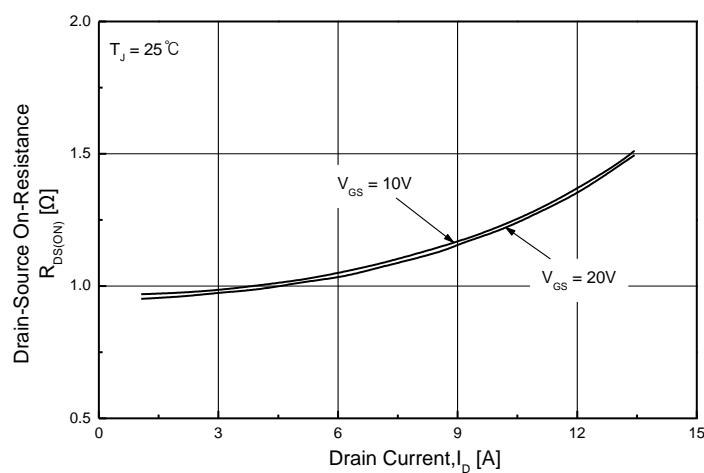
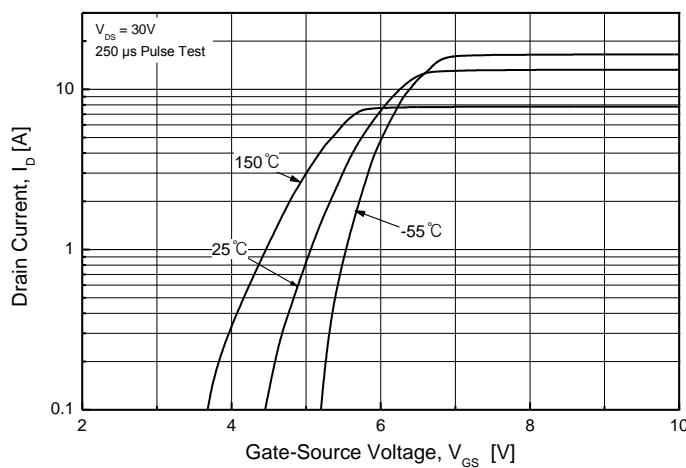
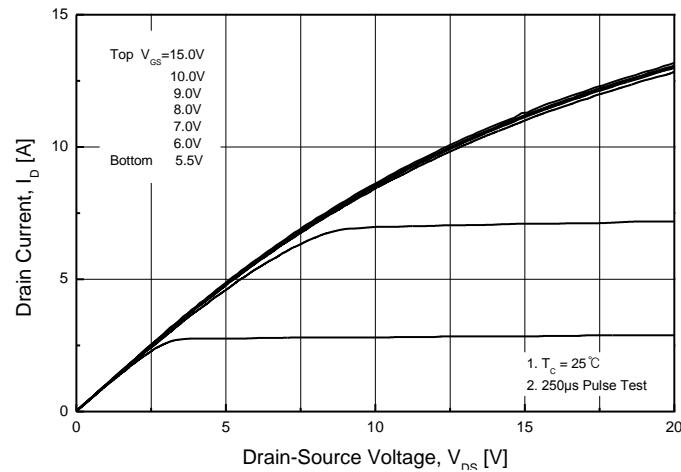
Parameter	Symbol	TMD7N60Z(G)/TMU7N60Z(G)	Unit
Maximum Thermal resistance, Junction-to-Case	$R_{\theta JC}$	1.04	°C/W
Maximum Thermal resistance, Junction-to-Ambient	$R_{\theta JA}$	110	°C/W

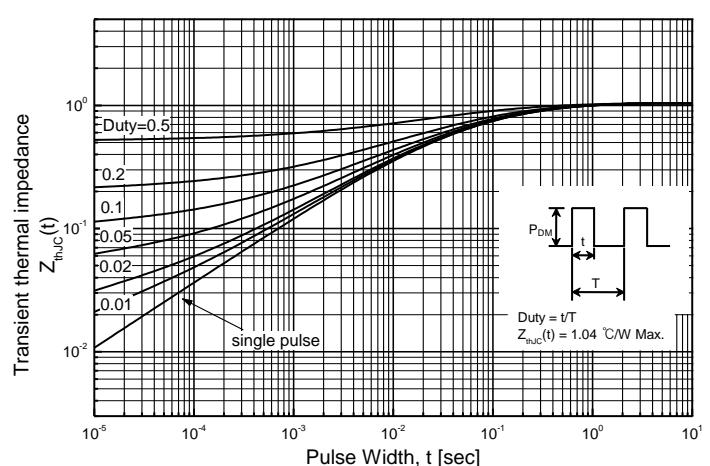
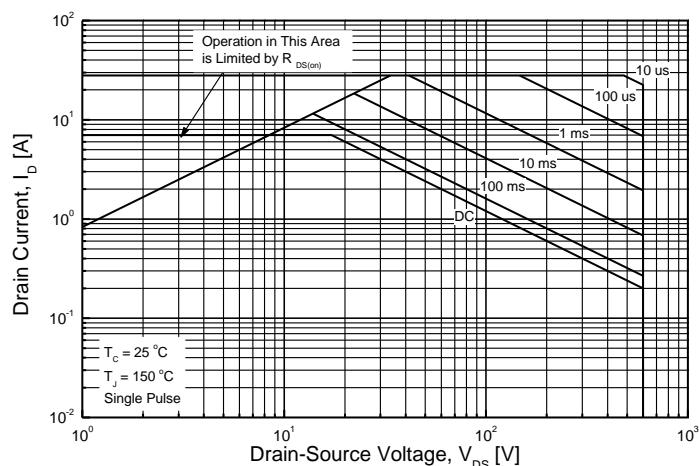
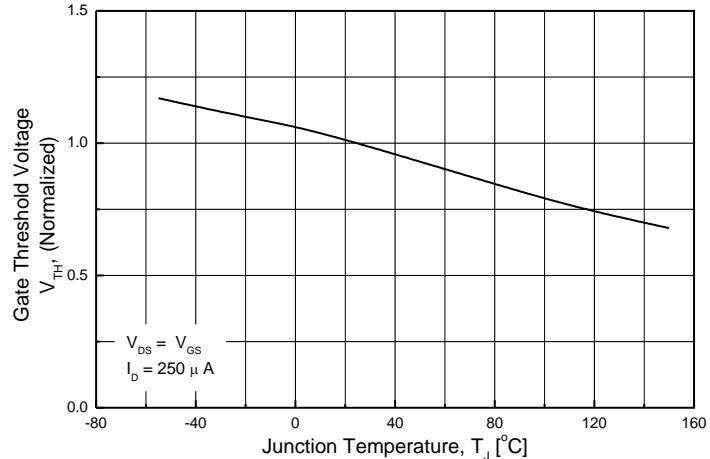
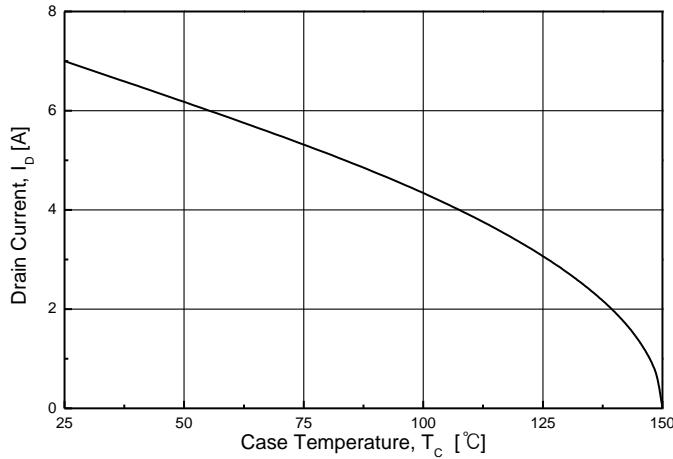
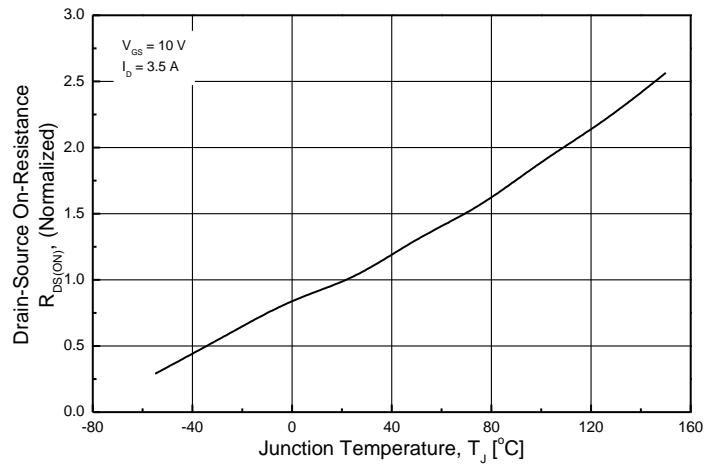
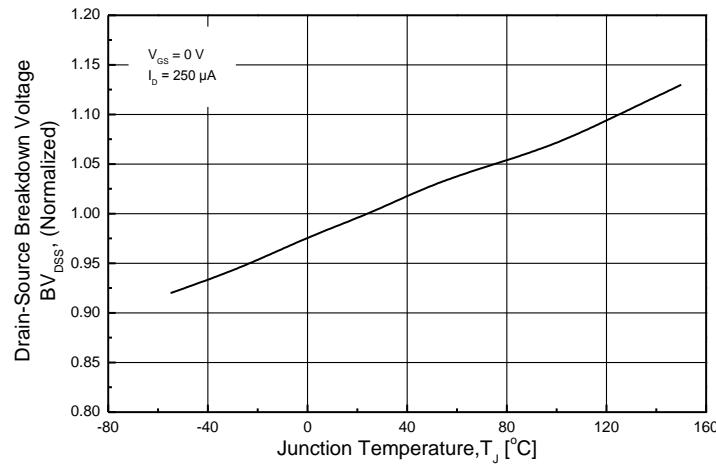
Electrical Characteristics : $T_c=25^\circ\text{C}$, unless otherwise noted

Parameter	Symbol	Test condition	Min	Typ	Max	Units
OFF						
Drain-Source Breakdown Voltage	BV_{DSS}	$V_{\text{GS}} = 0 \text{ V}, I_{\text{D}} = 250 \mu\text{A}$	600	--	--	V
Zero Gate Voltage Drain Current	I_{DSS}	$V_{\text{DS}} = 600 \text{ V}, V_{\text{GS}} = 0 \text{ V}$	--	--	1	μA
		$V_{\text{DS}} = 480 \text{ V}, T_c = 125^\circ\text{C}$	--	--	10	μA
Forward Gate-Source Leakage Current	I_{GSSF}	$V_{\text{GS}} = 30 \text{ V}, V_{\text{DS}} = 0 \text{ V}$	--	--	100	μA
Reverse Gate-Source Leakage Current	I_{GSSR}	$V_{\text{GS}} = -30 \text{ V}, V_{\text{DS}} = 0 \text{ V}$	--	--	-100	μA
ON						
Gate Threshold Voltage	$V_{\text{GS(th)}}$	$V_{\text{DS}} = V_{\text{GS}}, I_{\text{D}} = 250 \mu\text{A}$	3	--	5	V
Drain-Source On-Resistance	$R_{\text{DS(on)}}$	$V_{\text{GS}} = 10 \text{ V}, I_{\text{D}} = 3.5 \text{ A}$	--	1.0	1.2	Ω
Forward Transconductance ^(Note 4)	g_{FS}	$V_{\text{DS}} = 30 \text{ V}, I_{\text{D}} = 3.5 \text{ A}$	--	6.5	--	S
DYNAMIC						
Input Capacitance	C_{iss}	$V_{\text{DS}} = 25 \text{ V}, V_{\text{GS}} = 0 \text{ V}, f = 1.0 \text{ MHz}$	--	1001	--	pF
Output Capacitance	C_{oss}		--	104	--	pF
Reverse Transfer Capacitance	C_{rss}		--	9	--	pF
SWITCHING						
Turn-On Delay Time ^(Note 4,5)	$t_{\text{d(on)}}$	$V_{\text{DD}} = 300 \text{ V}, I_{\text{D}} = 7 \text{ A}, R_{\text{G}} = 25 \Omega$	--	32	--	ns
Turn-On Rise Time ^(Note 4,5)	t_r		--	35	--	ns
Turn-Off Delay Time ^(Note 4,5)	$t_{\text{d(off)}}$		--	71	--	ns
Turn-Off Fall Time ^(Note 4,5)	t_f		--	19	--	ns
Total Gate Charge ^(Note 4,5)	Q_g	$V_{\text{DS}} = 480 \text{ V}, I_{\text{D}} = 7 \text{ A}, V_{\text{GS}} = 10 \text{ V}$	--	19	--	nC
Gate-Source Charge ^(Note 4,5)	Q_{gs}		--	5	--	nC
Gate-Drain Charge ^(Note 4,5)	Q_{gd}		--	8	--	nC
SOURCE DRAIN DIODE						
Maximum Continuous Drain-Source Diode Forward Current	I_s	----	--	--	7	A
Maximum Pulsed Drain-Source Diode Forward Current	I_{SM}	----	--	--	28	A
Drain-Source Diode Forward Voltage	V_{SD}	$V_{\text{GS}} = 0 \text{ V}, I_s = 7 \text{ A}$	--	--	1.5	V
Reverse Recovery Time ^(Note 4)	t_{rr}	$V_{\text{GS}} = 0 \text{ V}, I_s = 7 \text{ A}$	--	345	--	ns
Reverse Recovery Charge ^(Note 4)	Q_{rr}		$dI_F / dt = 100 \text{ A}/\mu\text{s}$	--	2.7	μC

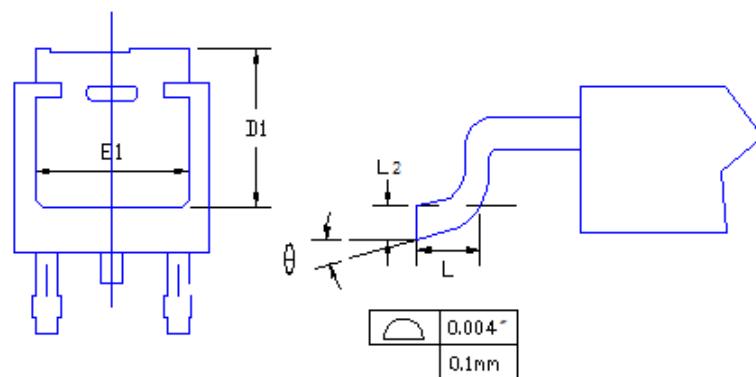
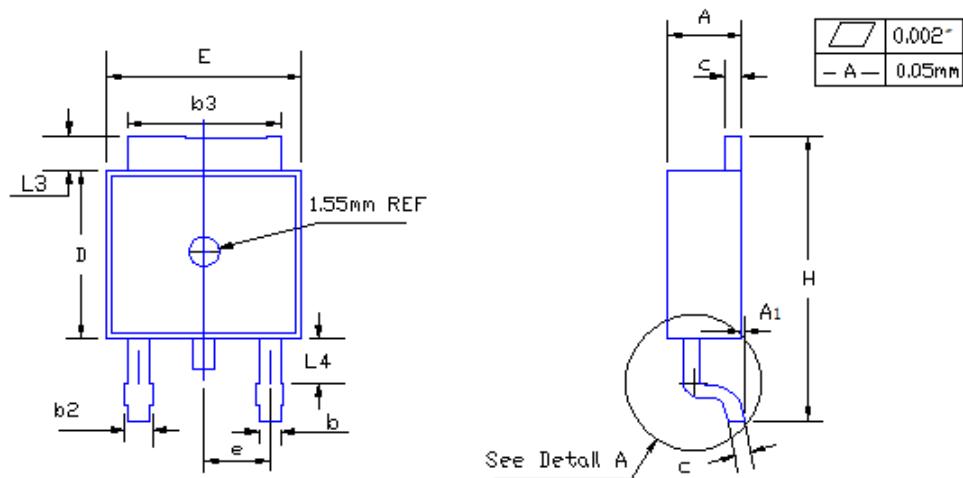
Note :

- Repeated rating : Pulse width limited by safe operating area
- $L=17.3\text{mH}, I_{\text{AS}} = 7\text{A}, V_{\text{DD}} = 50\text{V}, R_{\text{G}} = 25\Omega$, Starting $T_j = 25^\circ\text{C}$
- $I_{\text{SD}} \leq 7\text{A}, di/dt \leq 200\text{A}/\mu\text{s}, V_{\text{DD}} \leq \text{BV}_{\text{DS}}$, Starting $T_j = 25^\circ\text{C}$
- Pulse Test : Pulse width $\leq 300\mu\text{s}$, Duty Cycle $\leq 2\%$
- Essentially Independent of Operating Temperature Typical Characteristics



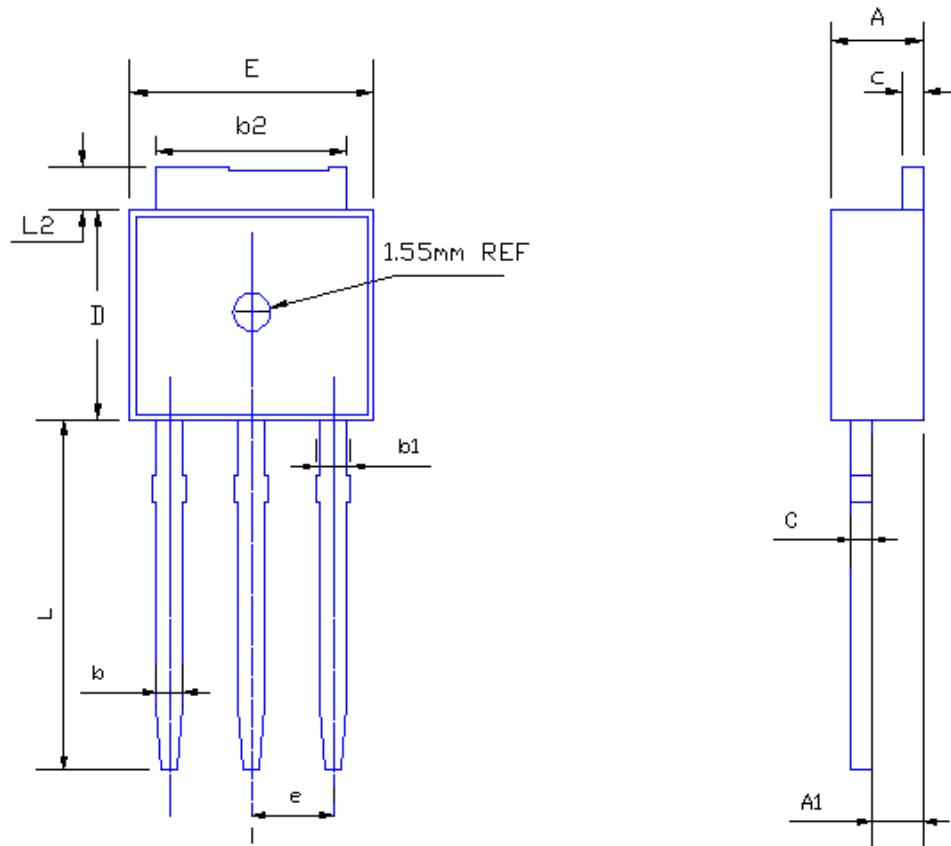


TO-252 (D-PAK) MECHANICAL DATA



SYMBOL	MILLIMETERS	
	MIN	MAX
A	2.19	2.38
A1	—	0.13
b	0.64	0.89
b2	0.84	1.14
b3	5.21	5.46
c	0.46	0.61
D	5.97	6.22
D1	5.21	—
E	6.35	6.73
E1	4.83	—
e	2.29BSC	
H	9.65	10.41
L	1.40	1.78
L2	0.51BSC	
L3	0.89	1.27
L4	0.64	1.01
θ	0	8

TO-251 (I-PAK) MECHANICAL DATA



SYMBOL	MILLIMETERS	
	MIN	MAX
A	2.19	2.38
A1	1.04	1.23
b	0.64	0.89
b1	0.84	1.14
b2	5.23	5.48
c	0.46	0.61
D	5.91	6.28
E	6.21	6.59
e	2.28 TYP	
L	8.89	9.65
L2	0.89	1.27